



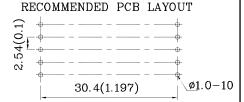
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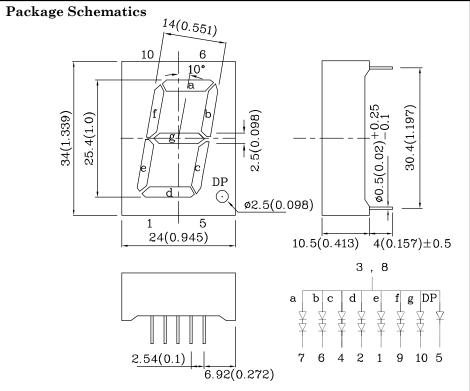
Features

- Low power consumption
- ullet Robust package
- I.C. Compatible
- Standard configuration: Gray face w/ white
- Optional black face provides superior color contrast
- RoHS Compliant









- 1. All dimensions are in millimeters (inches), Tolerance is \pm 0.25(0.01")unless otherwise noted.
- 2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		MYK (AlGaInP)	Unit	
Reverse Voltage (Per Chip)		5	V	
Forward Current (Dp)	I_{F}	30 (30)	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width (Dp)	ifs	175 (175)	mA	
Power Dissipation (Per Chip)	P_D	75	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3~5 Seconds			

Operating Characteristics (T _A =25°C)	MYK (AlGaInP)	Unit	
Forward Voltage (Typ.) (Dp) (IF=10mA)	V_{F}	3.9 (1.95)	V
Forward Voltage (Max.) (Dp) (IF=10mA)	V_{F}	5 (2.5)	V
Reverse Current (Max.) (Per Chip) (VR=5V)	I_{R}	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) $(I_F=10 \text{mA})$	λΡ	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	λD	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	20	pF

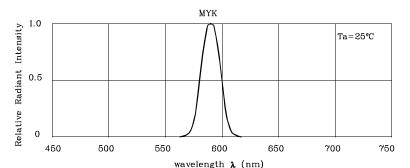
Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (IF=10mA) ucd		Wavelength CIE127-2007* Nm λP	Description
			min.	typ.		
XDMYK25A	Yellow	AlGaInP	150000 52000*	399990 139990*	590 *	Common Anode, Rt.Hand Decimal

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

XDSA5892 V2-X Layout: Maggie L.

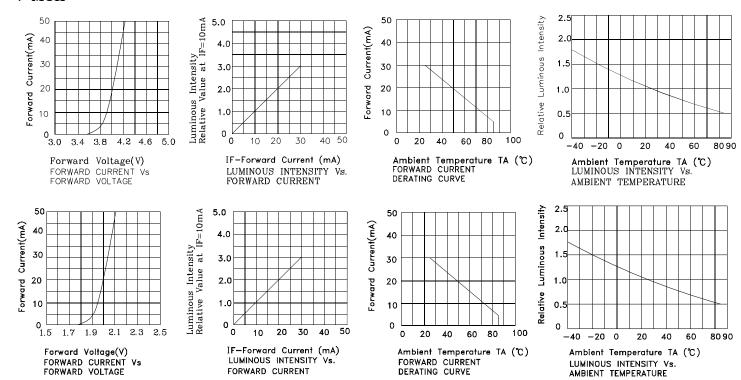




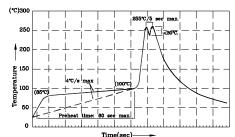


RELATIVE INTENSITY Vs. CIE WAVELENGTH

❖ MYK



Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- Notes:

 1. Recommend pre-heat temperature of 105°C or less (as measured thermocouple attached to the LED pins) prior to immersion in the wave with a maximum solder bath temperature of 260°C

 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sc
- 2.Peak wave soldering temperature outman, 3.Do not apply stress to the epoxy resin 4.Fixtures should not incur stress on the during soldering process.
 5.SAC 305 solder alloy is recommended.
 6.No more than one wave soldering pass.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

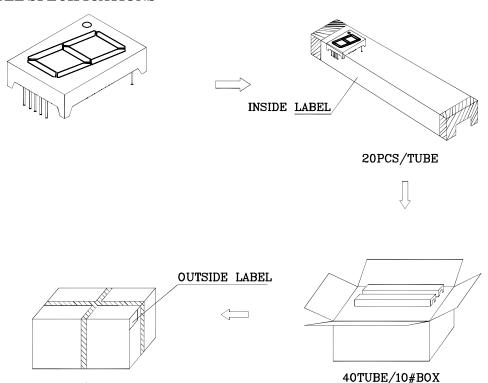
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

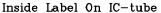
Note: Accuracy may depend on the sorting parameters.

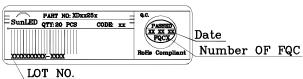


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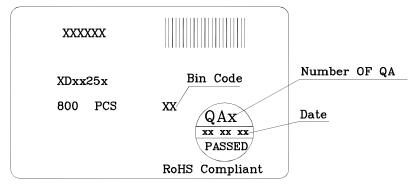
PACKING & LABEL SPECIFICATIONS







Outside Label On Box



TERMS OF USE

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- 5. The contents within this document may not be altered without prior consent by SunLED.

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 $6. \ Additional\ technical\ notes\ are\ available\ at\ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$

Jan 20,2014

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